



Product Change Notification

Change Notification #: 117073 - 00
Change Title: Intel® Server System R1208WFQYSR, PCN 117073-00, Label, Add URL to BIS mark to 1100W Power Supply label
Date of Publication: July 25, 2019

Key Characteristics of the Change:
 Label

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material*:	August 9, 2019
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*Intel appreciates the customer's desire to receive the latest revision of products. However, Intel manages inventory on a first in first out (FIFO) basis at the MM# level. Subsequently, customer requests for a specific revision of material (below the MM#) will not be supported by Intel.

Description of Change to the Customer:

Intel is implementing the following change on the Intel® Server System R1208WFQYSR:

- Update the label of the 1100 power supply included in the Intel® Server System R1208WFQYSR. The new label includes a URL of the BIS mark and remove "S&E" inside the CCC logo.

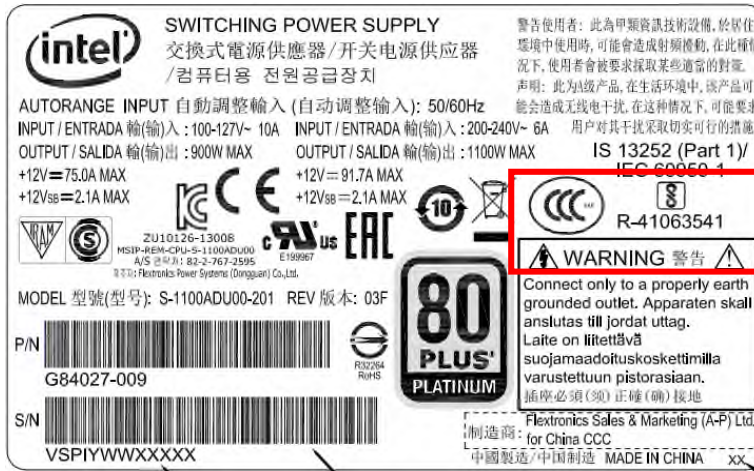


Image 1. Power supply label before change



Image 2. Power supply label after change

Customer Impact of Change and Recommended Action:

Intel does not expect any other impact to customers from these changes, but encourages customers to understand the change and determine the impact on their applications. For that reason Intel recommends that the customer perform a standard level of evaluation. Customers can download and evaluate the latest BIOS/ME/Integrated BMC and FRUSDR release notes for more information at <http://www.intel.com/support>.

Products Affected / Intel Ordering Codes:

Product Code	MM#	Pre Change TA	Post Change TA
R1208WFQYSR	986059	K40302-002	K40302-003

PCN Revision History:

Date of Revision:

July 25, 2019

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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